



DMN2005LP4K

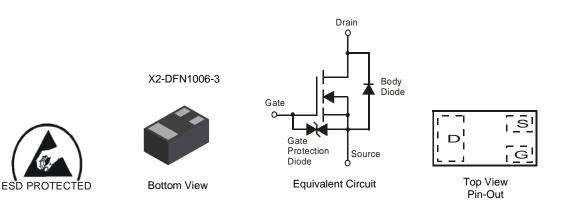
N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
- Very Low Gate Threshold Voltage, 0.9V Max.
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- **ESD Protected Gate**
- **Ultra Low Profile Package**
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu over Copper leadframe; Solderable per MIL-STD-202, Method 208 @4)
- Weight: 0.001 grams (Approximate)



Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
DMN2005LP4K-7	DN	7	8	3,000	
DMN2005LP4K-7B	DN	7	8	10,000	
DMN2005LP4K-7B DN 7 8 10,000 Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 10,000					

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information

DMN2005LPK-7	Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Top View Dot Denotes Drain SideTop View Bar Denotes Gate and Source SideImage: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Top View Dot Denotes Drain SideTop View Bar Denotes Gate and Source SideImage: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Top View Dot Denotes Drain SideTop View Bar Denotes Gate and Source SideImage: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this changes to:Image: DN from date code 1527 (YYWW), this code 1527 (YYWW), this code 1527 (YYWW), this
DMN2005LPK-7B	Top View Bar Denotes Gate and Source Side DN = Part Marking Code



Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	20	V
Gate-Source Voltage		V _{GSS}	±10	V
Drain Current per element (Note 5)	Continuous Pulsed (Note 6)	ID	300 350	mA

Thermal Characteristics (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	400	mW
Thermal Resistance, Junction to Ambient	$R_{ ext{ heta}JA}$	280	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	°C

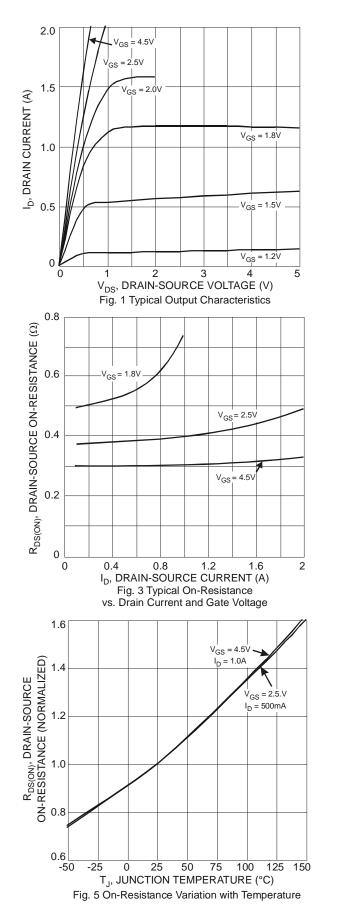
Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

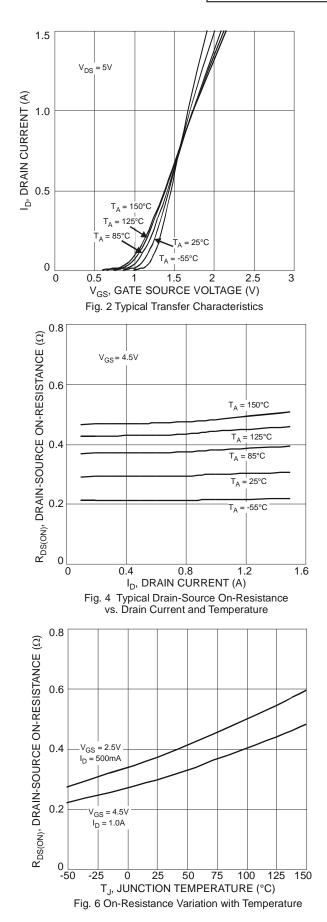
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (per elen	nent) (Note 7)						
Drain-Source Breakdown Voltage		BV _{DSS}	20			V	$V_{GS} = 0V, I_{D} = 100\mu A$
Zero Gate Voltage Drain Current		I _{DSS}		_	10	μA	$V_{DS} = 17V, V_{GS} = 0V$
Gate-Source Leakage		I _{GSS}			±5	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (per eleme	ON CHARACTERISTICS (per element) (Note 7)						
Gate Threshold Voltage		V _{GS(th)}	0.53		0.9	V	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$
Static Drain-Source On-Resistance		R _{DS (ON)}		0.35 0.4 0.45 0.55 0.65	1.5 1.7 1.7 3.5 3.5	Ω	
Forward Transfer Admittance		Y _{fs}	40			mS	$V_{DS} = 3V, I_{D} = 10mA$
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{iss}		37.1		pF	
Output Capacitance		C _{oss}	_	6.5		pF	V _{DS} = 10V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance		C _{rss}	_	4.8		pF	
Switching Time	Turn-On Time	t _{on}		4.06		nS	$V_{DD} = 10V, R_I = 47\Omega, V_{GEN} = 4.5V,$
	Turn-Off Time	t _{off}		13.7		113	$R_{GEN} = 10\Omega.$

Notes: 5. Device mounted on FR-4 PCB.

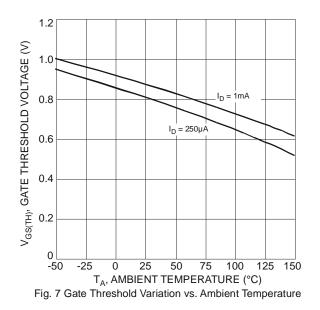
6. Pulse width $\leq 10\mu$ S, Duty Cycle $\leq 1\%$. 7. Short duration pulse test used to minimize self-heating effect.

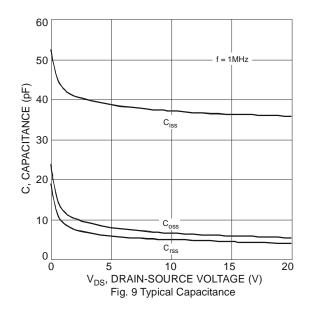


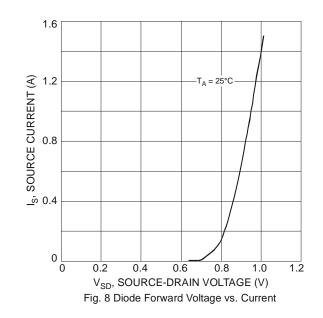








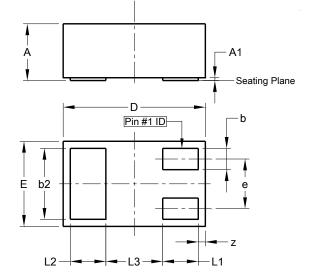






Package Outline Dimensions

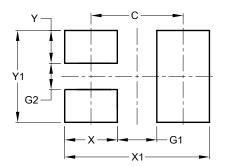
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X2-DFN1006-3					
Dim	Min	Max	Тур		
Α		0.40			
A1	0.00	0.05	0.03		
Ь	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.05	1.00		
Е	0.55	0.65	0.60		
е	-	1	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3	-	-	0.40		
Z	0.02	0.08	0.05		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Y	0.25
Y1	0.70



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